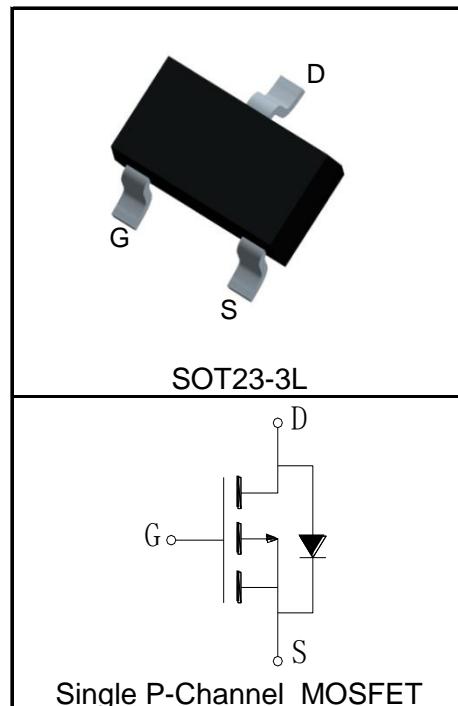


Features

- -20V/-6A,
- $R_{DS(ON)} = 25\text{m}\Omega(\text{Typ.}) @ V_{GS} = -4.5\text{V}$
- $R_{DS(ON)} = 34\text{m}\Omega(\text{Typ.}) @ V_{GS} = -2.5\text{V}$
- $R_{DS(ON)} = 42\text{m}\Omega(\text{Typ.}) @ V_{GS} = -1.8\text{V}$
- Low $R_{DS(ON)}$
- Super High Dense Cell Design
- Reliable and Rugged

Pin Description



Applications

- Load Switch



Halogen-Free

Absolute Maximum Ratings

| Symbol | Parameter | Rating | Unit |
|--|--|--------------------------|--------------------|
| Common Ratings ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted) | | | |
| V_{DSS} | Drain-Source Voltage | -20 | V |
| V_{GSS} | Gate-Source Voltage | ± 12 | |
| T_J | Maximum Junction Temperature | 150 | $^\circ\text{C}$ |
| T_{STG} | Storage Temperature Range | -55 to 150 | $^\circ\text{C}$ |
| I_S | Diode Continuous Forward Current | $T_A = 25^\circ\text{C}$ | -1.2 |
| Mounted on Large Heat Sink | | | |
| $I_{DP}^{①}$ | 300 μs Pulse Drain Current Tested | $T_A = 25^\circ\text{C}$ | -24 |
| $I_D^{②}$ | Continuous Drain Current ($V_{GS} = -4.5\text{V}$) | $T_A = 25^\circ\text{C}$ | -6 |
| | | $T_A = 70^\circ\text{C}$ | -4 |
| P_D | Maximum Power Dissipation | $T_A = 25^\circ\text{C}$ | 1.25 |
| | | $T_A = 70^\circ\text{C}$ | 0.8 |
| $R_{\theta JC}$ | Thermal Resistance-Junction to Case | - | $^\circ\text{C/W}$ |
| $R_{\theta JA}^{③}$ | Thermal Resistance-Junction to Ambient | 100 | $^\circ\text{C/W}$ |
| Drain-Source Avalanche Ratings | | | |
| $E_{AS}^{④}$ | Avalanche Energy, Single Pulsed | TBD | mJ |

Electrical Characteristics ($T_A=25^\circ\text{C}$ Unless Otherwise Noted)

| Symbol | Parameter | Test Condition | KS2322EB | | | Unit |
|---|----------------------------------|---|----------|-------|-----------|------------------|
| | | | Min. | Typ. | Max. | |
| Static Characteristics | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $\text{V}_{\text{GS}}=0\text{V}, \text{I}_{\text{DS}}=-250\mu\text{A}$ | -20 | | | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $\text{V}_{\text{DS}}=-20\text{V}, \text{V}_{\text{GS}}=0\text{V}$ | | | -1 | μA |
| | | $\text{T}_J=125^\circ\text{C}$ | | | -100 | |
| $\text{V}_{\text{GS}(\text{th})}$ | Gate Threshold Voltage | $\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_{\text{DS}}=-250\mu\text{A}$ | -0.4 | -0.6 | -1 | V |
| I_{GSS} | Gate Leakage Current | $\text{V}_{\text{GS}}=\pm 12\text{V}, \text{V}_{\text{DS}}=0\text{V}$ | | | ± 100 | nA |
| $\text{R}_{\text{DS}(\text{ON})}^{(5)}$ | Drain-Source On-state Resistance | $\text{V}_{\text{GS}}=-4.5\text{V}, \text{I}_{\text{DS}}=-4\text{A}$ | | 25 | 32 | $\text{m}\Omega$ |
| | | $\text{V}_{\text{GS}}=-2.5\text{V}, \text{I}_{\text{DS}}=-2\text{A}$ | | 34 | 44 | $\text{m}\Omega$ |
| | | $\text{V}_{\text{GS}}=-1.8\text{V}, \text{I}_{\text{DS}}=-1.5\text{A}$ | | 42 | 55 | $\text{m}\Omega$ |
| Diode Characteristics | | | | | | |
| $\text{V}_{\text{SD}}^{(5)}$ | Diode Forward Voltage | $\text{I}_{\text{SD}}=-4\text{A}, \text{V}_{\text{GS}}=0\text{V}$ | | -0.81 | -1.2 | V |
| t_{rr} | Reverse Recovery Time | $\text{I}_{\text{SD}}=-4\text{A}, \frac{d\text{I}_{\text{SD}}}{dt}=-100\text{A}/\mu\text{s}$ | | 12 | | ns |
| Q_{rr} | Reverse Recovery Charge | | | 23 | | nC |
| Dynamic Characteristics ⁽⁶⁾ | | | | | | |
| R_G | Gate Resistance | $\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=0\text{V}, \text{F}=1\text{MHz}$ | | 6.9 | | Ω |
| C_{iss} | Input Capacitance | $\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=-10\text{V}, \text{Frequency}=1.0\text{MHz}$ | | 1595 | | pF |
| C_{oss} | Output Capacitance | | | 185 | | |
| C_{rss} | Reverse Transfer Capacitance | | | 120 | | |
| $\text{t}_{\text{d}(\text{ON})}$ | Turn-on Delay Time | $\text{V}_{\text{DD}}=-10\text{V}, \text{I}_{\text{DS}}=-4\text{A}, \text{V}_{\text{GEN}}=-4.5\text{V}, \text{R}_G=6\Omega$ | | 15 | | ns |
| t_{r} | Turn-on Rise Time | | | 28 | | |
| $\text{t}_{\text{d}(\text{OFF})}$ | Turn-off Delay Time | | | 39 | | |
| t_{f} | Turn-off Fall Time | | | 27 | | |
| Gate Charge Characteristics ⁽⁶⁾ | | | | | | |
| Q_g | Total Gate Charge | $\text{V}_{\text{DS}}=-10\text{V}, \text{V}_{\text{GS}}=-4.5\text{V}, \text{I}_{\text{DS}}=-4\text{A}$ | | 18 | | nC |
| Q_{gs} | Gate-Source Charge | | | 5 | | |
| Q_{gd} | Gate-Drain Charge | | | 7 | | |

Notes: (1)Pulse width limited by safe operating area.

(2)Calculated continuous current based on maximum allowable junction temperature.

(3)When mounted on 1 inch square copper board, $t \leq 10\text{sec}$. The value in any given application depends on the user's specific board design.

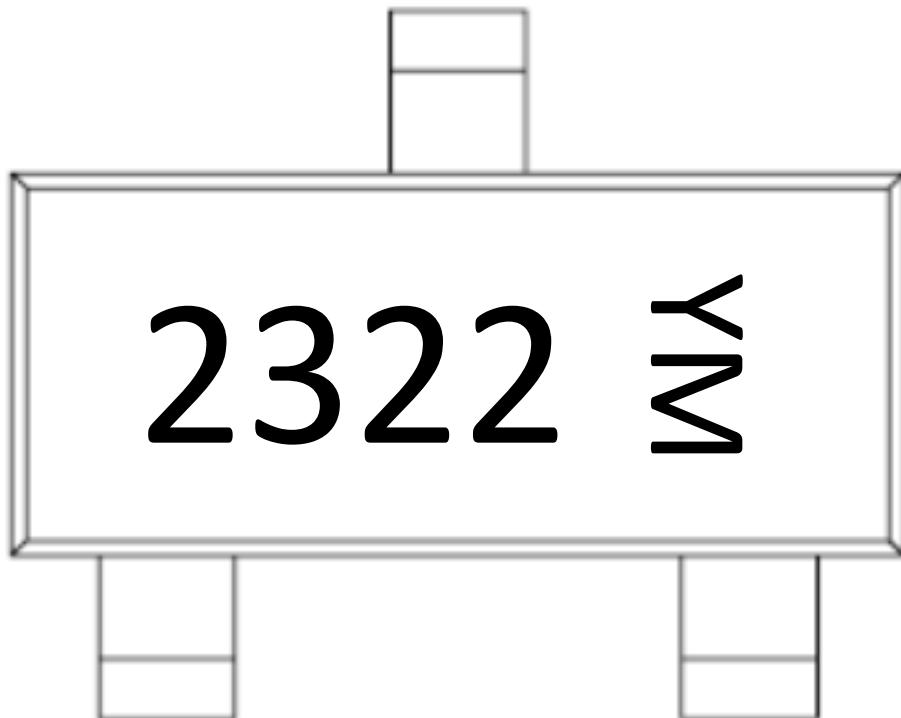
(4)Limited by T_{Jmax} . Starting $\text{T}_J = 25^\circ\text{C}$.

(5)Pulse test; Pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.

(6)Guaranteed by design, not subject to production testing.

Ordering and Marking Information

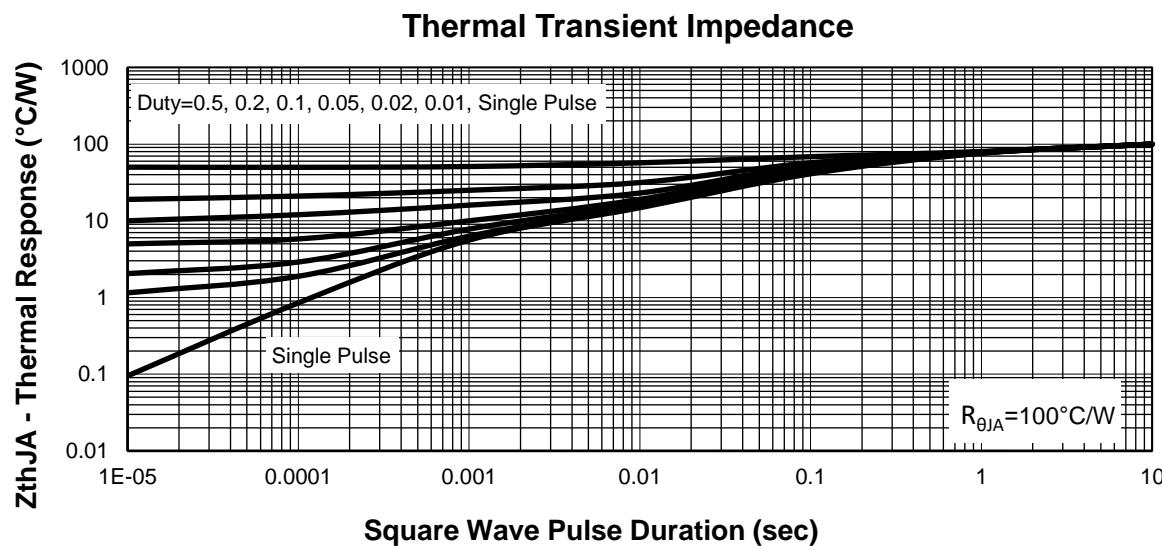
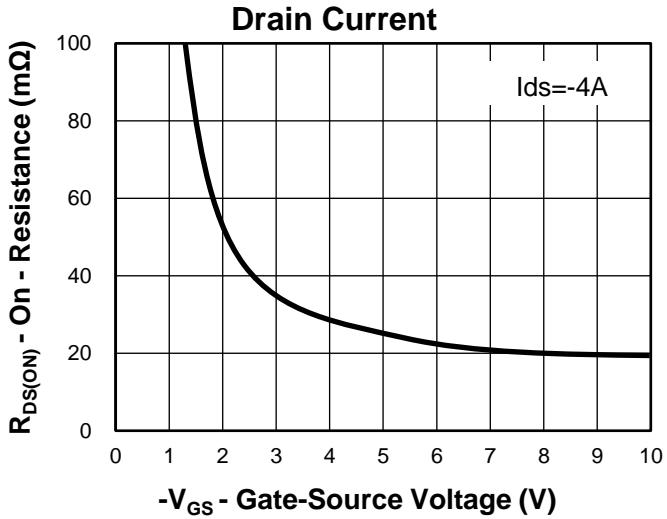
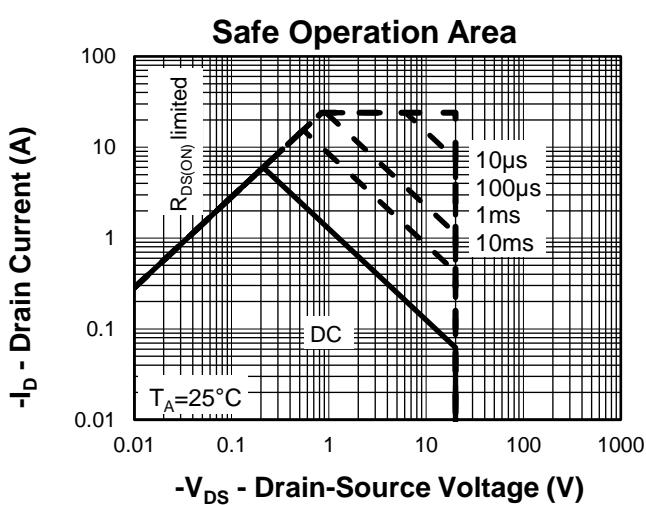
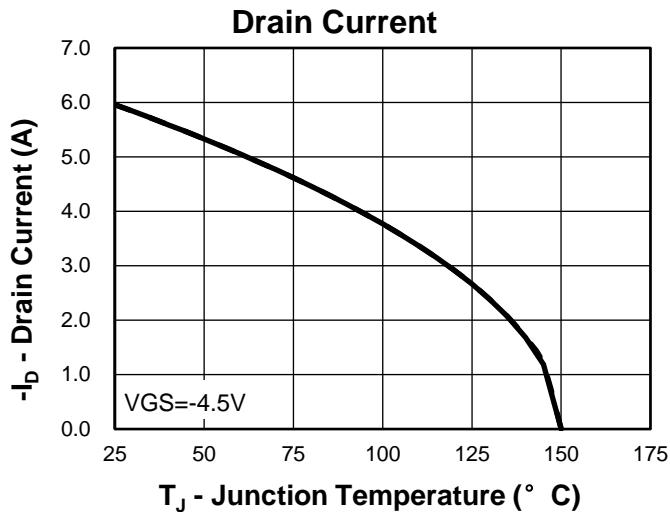
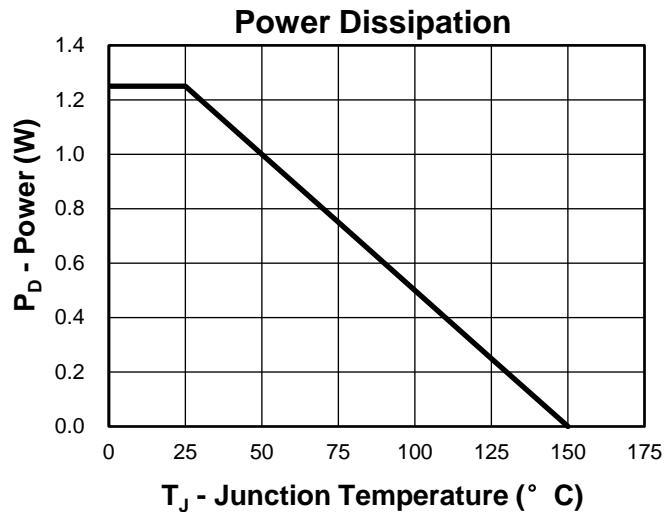
| Device | Package | Packaging | Quantity | Reel Size | Tape width |
|----------|----------|-----------|----------|-----------|------------|
| KS2322EB | SOT23-3L | Tape&Reel | 3000 | 7" | 8mm |



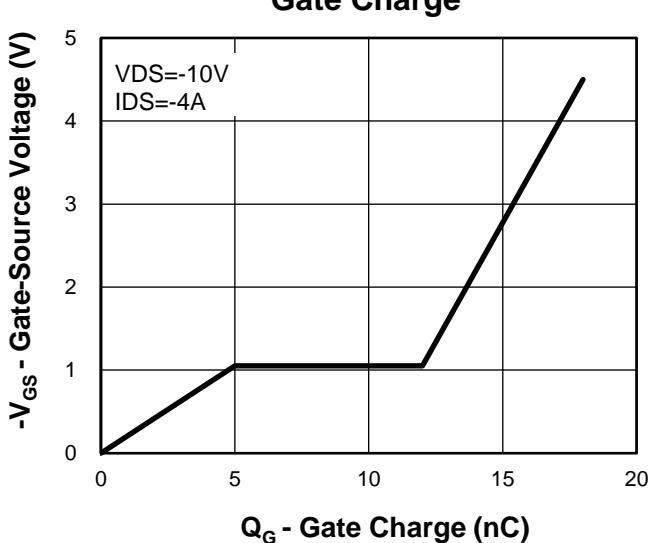
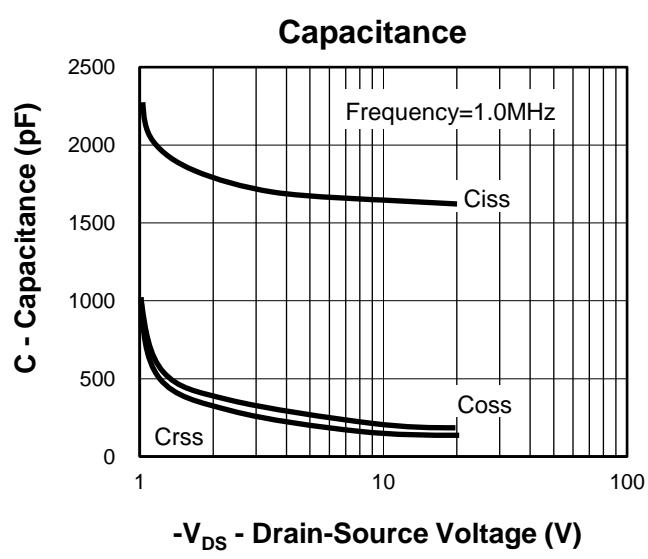
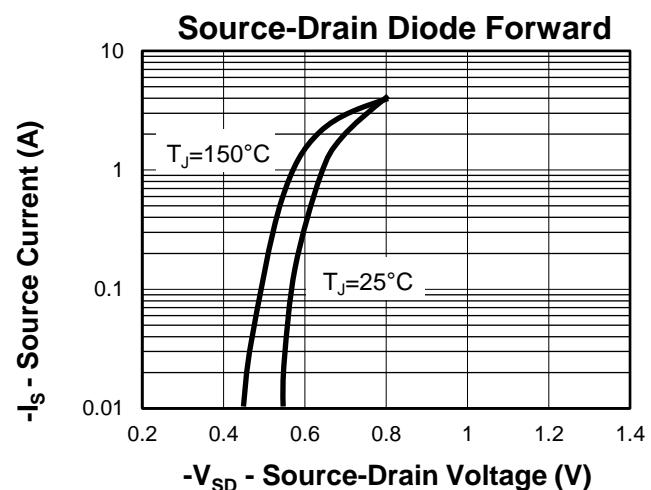
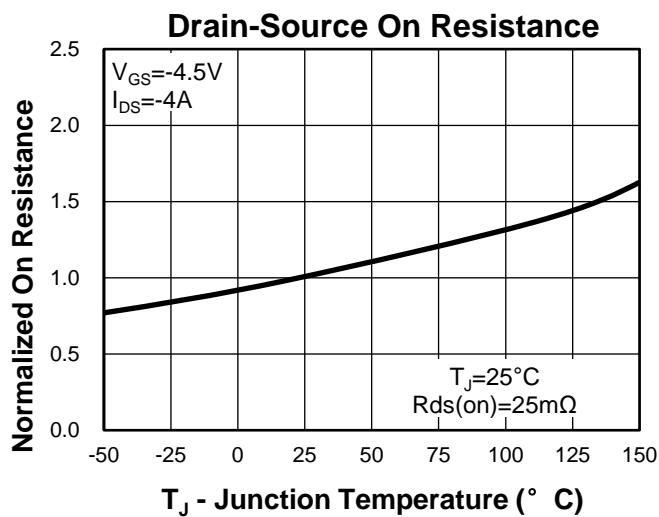
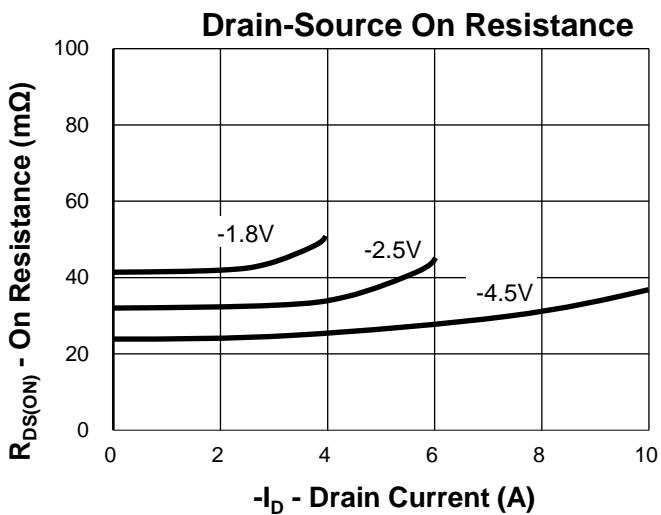
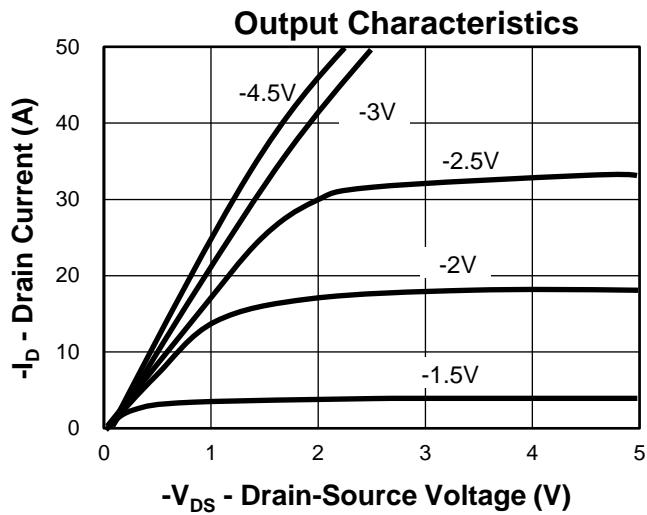
Y =Year,2017-A,2018-B,etc.

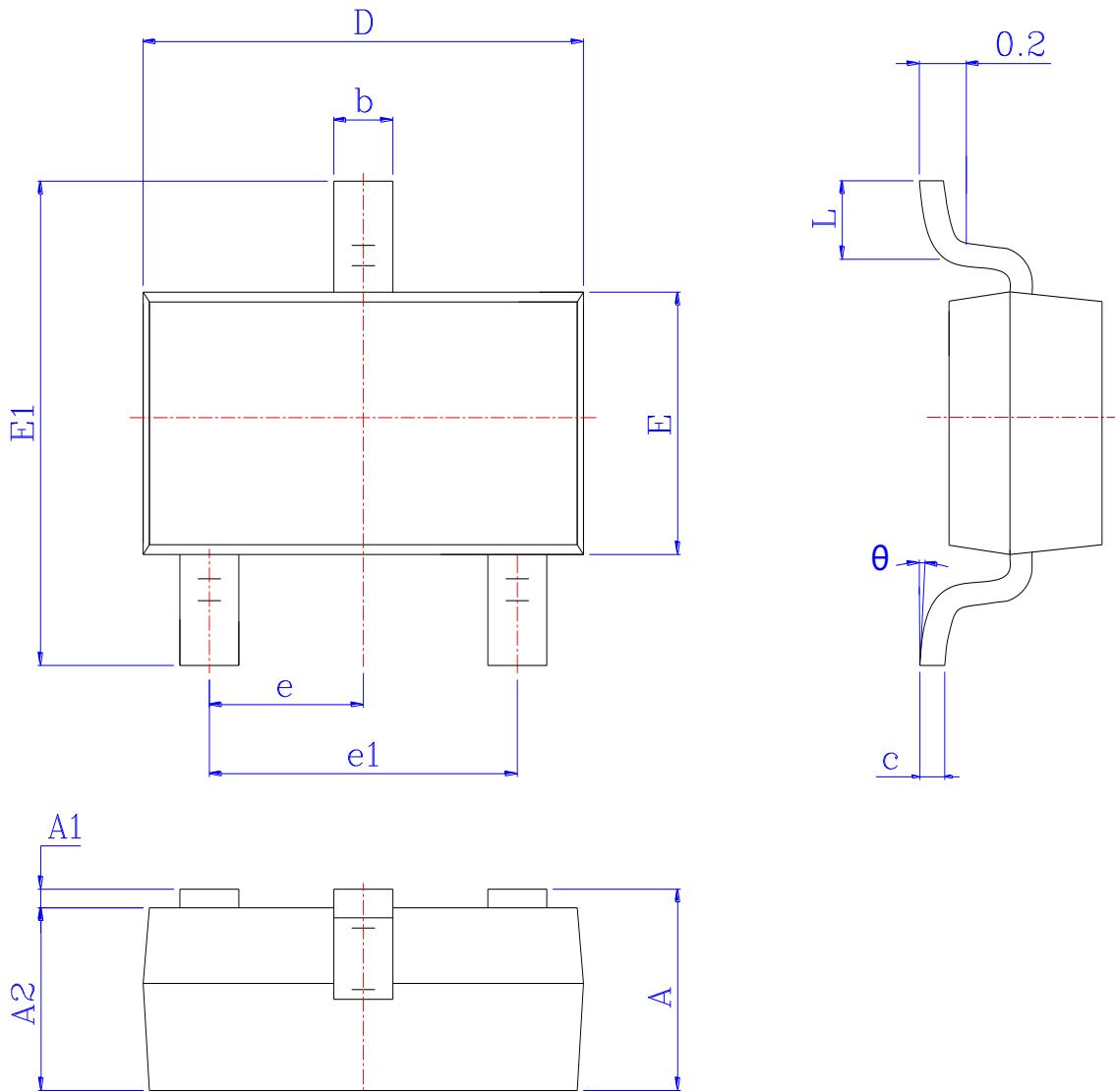
M =Month,Jan-1,Feb-2,...,Sep-9,Oct-A,Nov-B,Dec-C.

Typical Characteristics



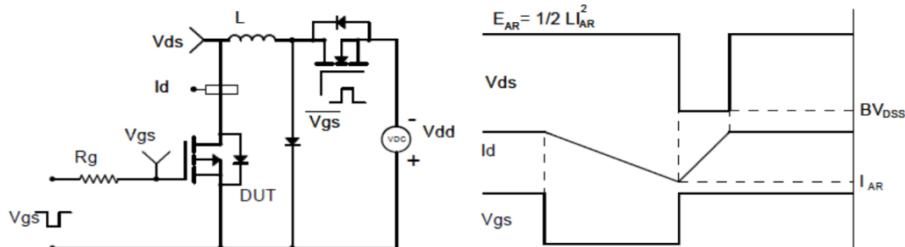
Typical Characteristics



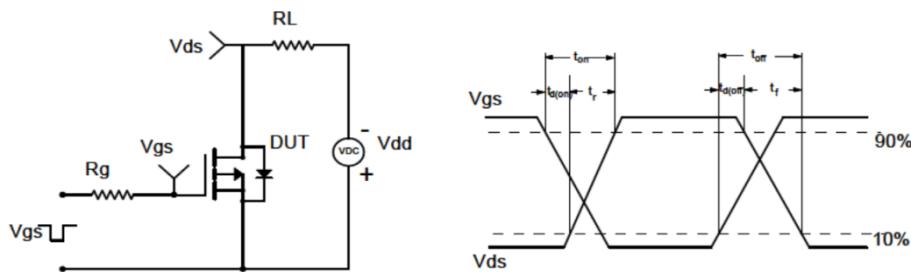
Package Information
SOT23-3L


| SYMBOL | MM | | | INCH | | |
|----------|-----------|-------|-------|-----------|-------|-------|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 0.950 | 1.150 | 1.450 | 0.037 | 0.045 | 0.057 |
| A1 | 0.000 | * | 0.150 | 0.000 | * | 0.006 |
| A2 | 0.900 | 1.100 | 1.300 | 0.035 | 0.043 | 0.051 |
| b | 0.300 | 0.400 | 0.500 | 0.012 | 0.016 | 0.020 |
| c | 0.080 | 0.150 | 0.200 | 0.003 | 0.006 | 0.008 |
| D | 2.800 | 2.925 | 3.050 | 0.110 | 0.115 | 0.120 |
| E | 1.500 | 1.600 | 1.750 | 0.059 | 0.063 | 0.069 |
| E1 | 2.650 | 2.800 | 3.000 | 0.104 | 0.110 | 0.118 |
| e | 0.950 BSC | | | 0.037 BSC | | |
| e1 | 1.800 | 1.900 | 2.000 | 0.071 | 0.075 | 0.079 |
| L | 0.300 | 0.450 | 0.600 | 0.012 | 0.018 | 0.024 |
| θ | 0° | 4° | 8° | 0° | 4° | 8° |

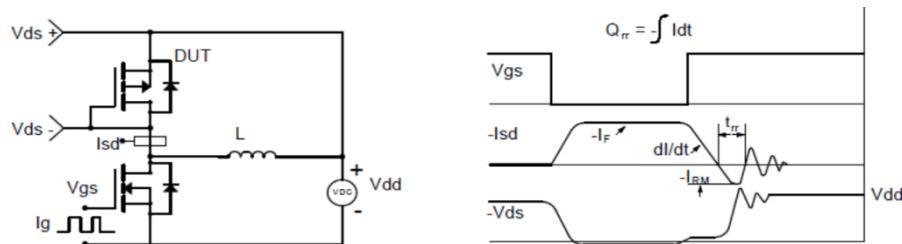
Avalanche Test Circuit and Waveforms



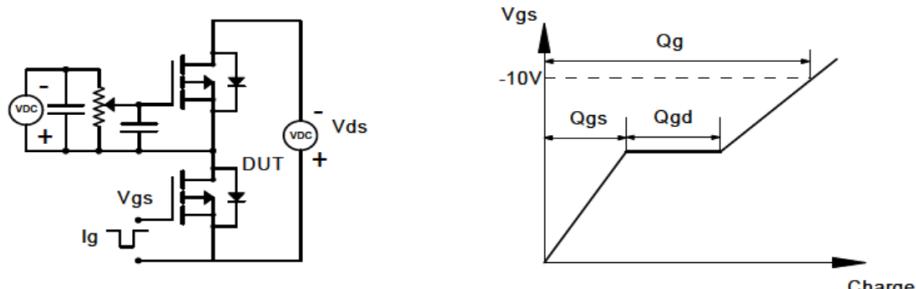
Switching Time Test Circuit and Waveforms



Diode Recovery Test Circuit and Waveforms



Gate Charge Test Circuit and Waveform



Customer Service

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Web:www.kwansemi.com

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